



Material Content Data Sheet



Sales Product Name		IPB60R280P6		Issued		24. January 2018		
MA#		MA001595310						
Package		PG-TO263-3-2		Weight*		1562.66 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.826	0.37	0.37	3728	3728
leadframe	non noble metal	iron	7439-89-6	0.304	0.02		195	
	inorganic material	phosphorus	7723-14-0	0.091	0.01		58	
	non noble metal	copper	7440-50-8	304.026	19.46	19.49	194557	194810
wire	non noble metal	aluminium	7429-90-5	26.600	1.70	1.70	17023	17023
encapsulation	organic material	carbon black	1333-86-4	9.947	0.64		6365	
	plastics	epoxy resin	-	109.416	7.00		70019	
	inorganic material	silicondioxide	60676-86-0	543.763	34.80	42.44	347974	424358
leadfinish	non noble metal	tin	7440-31-5	9.657	0.62	0.62	6180	6180
plating	non noble metal	nickel	7440-02-0	0.228	0.01		146	
	inorganic material	phosphorus	7723-14-0	0.001	0.00	0.01	1	146
solder	noble metal	silver	7440-22-4	0.110	0.01		71	
	non noble metal	tin	7440-31-5	0.088	0.01		57	
	non noble metal	lead	7439-92-1	4.219	0.27	0.29	2700	2828
heatspreader	non noble metal	iron	7439-89-6	0.548	0.04		351	
	inorganic material	phosphorus	7723-14-0	0.165	0.01		105	
	non noble metal	copper	7440-50-8	547.666	35.03	35.08	350470	350927
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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